



103212756

Tab settings → → → ▼ ▼

To the Director of the United States Patent and Trademark Office, for the filing of original documents or copy thereof.

3-29-06

1. Name of conveying party(ies):
Sang-Hoon LEE, Keun-Woo PARK, Pil-Mo CHOI, Ung-Sik KIM, Kook-Chul MOON

2. Name and address of receiving party(ies):

Name: **SAMSUNG ELECTRONICS CO., LTD.**

Address: **416, Maetan-dong, Yeongtong-gu**

Additional names(s) of conveying party(ies) Yes No

112991 U.S. PTO
11/392446

032906

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

City: **Suwon-si** State/Prov.: **Gyeonggi-do**

Country: **Korea** ZIP: _____

Execution Date: **March 10, 2006**

Additional name(s) & address(es) Yes No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: **March 10, 2006**

Patent Application No. Filing date

B. Patent No.(s)

Additional numbers Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: **Amy Bizon-Copp**

Registration No. **53,993**

Address: **Cantor Colburn LLP**

55 Griffin Road South

City: **Bloomfield** State/Prov.: **CT**

Country: **USA** ZIP: **06002**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41):.....\$ **40.00**

Enclosed - Any excess or insufficiency should be credited or debited to deposit account

Authorized to be charged to deposit account

8. Deposit account number:

06-1130

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Amy Bizon-Copp

Name of Person Signing

Amy Bizon-Copp
Signature

March 29, 2006

Date

Total number of pages including cover sheet, attachments, and document: **3**

ASSIGNMENT

WHEREAS We, LEE, Sang-Hoon of 502 Ace Ville, 43-12 Samjeon-dong, Songpa-gu, Seoul Korea; PARK, Keun-Woo of 5-901 Gaepo Hansin apt., Dogok 2-dong, Gangnam-gu, Korea; CHOI, Pil-Mo of 103, 1651-3 Bongcheon 11-dong, Gwanak-gu, Seoul, Korea; KIM, Ung-Sik of 116-1704 Neulpureun Byeoksan apt., Mangpo-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea; and MOON, Kook-Chul of 404-301 Hyundai apt., Sinbong-dong, Yongin-si, Gyeonggi-do, Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

CIRCUIT BOARD AND DISPLAY DEVICE HAVING THE SAME

which claims priority to Korean Patent Application No. 10-2005-0025943, filed on March 29, 2005, and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, **SAMSUNG ELECTRONICS CO., LTD.** (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea having a place of business at **416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;


NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will


Opp050427us


1/2

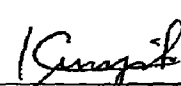
execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.


The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon:

Date: 10/03/2006 LEE, Sang-Hoon  L.S.
LEE, Sang-Hoon

Date: 10/03/2006 PARK Keun-Woo  L.S.
PARK, Keun-Woo

Date: 10/03/2006 CHOI Pil-Mo  L.S.
CHOI, Pil-Mo

Date: 10/03/2006 UNGSIK KIM  L.S.
KIM, Ung-Sik

Date: 10/03/2006 MOON, Kook-Chul  L.S.
MOON, Kook-Chul